

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Beilin et al.
Serial No.: Unassigned
Filed: Herewith
For: METHODS OF PLANARIZING
STRUCTURES ON WAFERS
AND SUBSTRATES BY POLISHING
Examiner: S. Ahmed
Group Art Unit: 1746
Attorney Docket: 25916-111 (53755)

**CERTIFICATE OF MAILING
BY "EXPRESS MAIL"**

"Express Mail" Mailing Label Number:

EL 580397012 US

I hereby certify that this paper, accompanying documents and fee are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" Service under 37 CFR §1.10 on the date indicated below and are addressed to: Commissioner for Patents, **Box Patent Application**, Washington, DC 20231-0001.

June 12, 2001

By

Jordan Wilson

PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Please enter the following Preliminary Amendment to the accompanying patent application:

In The Specification:

On page 1, line 3, before 'FIELD OF THE INVENTION', insert the following paragraph:

A¹ This application is a continuation application of copending applications having Serial No. 09/259,125, filed February 26, 1999. Application Serial No. 09/259,125 is a continuation application of application having Serial No. 08/717,266, filed on September 20, 1996. Benefit of all earlier filing dates is claimed.